

Day : Sunday
Date: 8/20/2006

Time: 11:00:44



Inventor Name Search Result

Your Search was:

Last Name = OGIWARA

First Name = TOSHIAKI

Application#	Patent#	Status	Date Filed	Title	Inventor Name
06038261	4238455	150	05/11/1979	DENITRIFICATION REACTOR	OGIWARA, TOSHIAKI
08464753	Not Issued	161	06/15/1995	PROCESS FOR PRODUCING A HIGH MOLECULAR WEIGHT EPOXY RESIN	OGIWARA, TOSHIAKI
10468425	Not Issued	161	08/18/2003	Composition for filling through- holes in printed wiring boards	OGIWARA, TOSHIAKI
10786489	Not Issued	30	02/25/2004	Composition of conductive paste	OGIWARA, TOSHIAKI
10968605	Not Issued	61	10/19/2004	Electroconductive paste composition	OGIWARA, TOSHIAKI
60184938	Not Issued	159	02/25/2000	Silver paste composition for forming electrically conductive vias	OGIWARA, TOSHIAKI
60279206	Not Issued	159	03/28/2001	Composition for filling through- holes	OGIWARA, TOSHIAKI

Inventor Search Completed: No Records to Display.

Search Another: Inventor	Last Name	First Name	<input type="button" value="Search"/>
	<input type="text" value="OGIWARA"/>	<input type="text" value="TOSHIAKI"/>	

To go back use Back button on your browser toolbar.

Back to [PALM](#) | [ASSIGNMENT](#) | [OASIS](#) | [Home page](#)

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1373	(conductive or conductor or electroconduct\$ or thick film) and (maruzen)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWENT	ADJ	ON	2006/08/20 11:57
L2	572	l1 and (pi or pl or polyimide)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWENT	ADJ	ON	2006/08/20 11:55
L3	42	maruzen with (pi100 or pi-100 or pl-100 or pl100 or pi117 or pi-117 or pl117 or pl-117 or polyimide)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWENT	ADJ	ON	2006/08/20 11:56
L4	20	l3 and (conductive or conductor or electroconduct\$ or thick film)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWENT	ADJ	ON	2006/08/20 12:08
L5	26343	(conductive or conductor or electroconductive) and (solvent) and (polyimide)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWENT	ADJ	ON	2006/08/20 12:09

EAST Search History

L6	0	I5 and "252/512-514.ccls"	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 12:10
L7	3987	252/512-514.ccls.	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 12:10
L8	219	I5 and I7	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 12:10
L9	1	I8 and (maruzen)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 12:12
L10	11	I8 and (polyimide with formula)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 12:14

EAST Search History

L11	1055	I5 and (polyimide with formula)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 12:15
L12	476	I5 and (polyimide with formula).clm,ab.	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 12:15
L13	467	I12 not I10	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T	ADJ	ON	2006/08/20 12:15

d full his

(FILE 'HOME' ENTERED AT 12:38:30 ON 20 AUG 2006)

FILE 'CAPLUS' ENTERED AT 12:38:42 ON 20 AUG 2006

L1 182 SEA (PI-100 OR PI100 OR PI-117 OR PI117 OR MARUZEN)
L2 12 SEA L1 AND (CONDUCTIVE OR ELECTROCONDUCT? OR PASTE OR THICK
FILM)
D 1-12 IALL

FILE 'STNGUIDE' ENTERED AT 12:40:57 ON 20 AUG 2006

FILE HOME

FILE CAPLUS

Copyright of the articles to which records in this database refer is held by the publishers listed in the PUBLISHER (PB) field (available for records published or updated in Chemical Abstracts after December 26, 1996), unless otherwise indicated in the original publications. The CA Lexicon is the copyrighted intellectual property of the American Chemical Society and is provided to assist you in searching databases on STN. Any dissemination, distribution, copying, or storing of this information, without the prior written consent of CAS, is strictly prohibited.

FILE COVERS 1907 - 20 Aug 2006 VOL 145 ISS 9

FILE LAST UPDATED: 18 Aug 2006 (20060818/ED)

Effective October 17, 2005, revised CAS Information Use Policies apply. They are available for your review at:

<http://www.cas.org/infopolicy.html>

FILE STNGUIDE

FILE CONTAINS CURRENT INFORMATION.

LAST RELOADED: Aug 18, 2006 (20060818/UP).